

L Number	Hits	Search Text	DB	Time stamp
1	8	((349/\$ and (heat\$4 near8 substrate) and (tensile near4 stress)) and (groove)) and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/07 09:11
2	285	349/200	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/07 09:12
3	1622	349/158	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/07 09:12
4	1520	349/122	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/07 09:12
5	195	349/22	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/07 09:12
-	94	((liquid near3 crystal) or lcd) and plate and (stress near5 edge)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/16 14:19
-	24	((((liquid near3 crystal) or lcd) and plate and (stress near5 edge)) and 349/\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/21 07:58
-	263	349/200	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 17:02
-	1470	349/158	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 17:02
-	1295	349/122	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/20 17:02
-	4	((((liquid near3 crystal) or lcd) and plate and (stress near5 edge)) and 349/\$5 and ((laser or cut or cutting) near6 glass)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/21 08:03
-	184	349/22	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/21 08:03

-	99	349/22 and glass	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/21 08:03
-	8	(349/22 and glass) and stress	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/21 08:04
-	7	(349/22 and glass) and stress and plate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/03/21 08:04
-	6	(3909226, 5385786, "4826522").pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/07 10:03
-	272	349/200	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/16 14:19
-	1528	349/158	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/16 14:19
-	1424	349/122	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/16 14:19
-	187	349/22	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/16 14:19